

| interdita S INC. | | | 1 | | | 2 | | | |
|---|-------------------|-------------|-------------|------------|------------|------------|--------|--|--|
| des tiers in aire. ELECTRONICS | PRODUCT No. | PORTS No | DIM A +0.60 | DIM B±0.20 | DIM C±0.10 | DIM D±0.15 | | | |
| s ti e. ECTRE | 95679-X01/X01LF | 1 | 15.24 | | 5.715 | 11.43 | | | |
| | 95679-X02/X02LF | 2 | 30.48 | 13.97 | 12.700 | 25.40 | | | |
| ion opte | 95679-X03/X03LF | 3 | 44.45 | 27.94 | 19.685 | 39.37 | | | |
| mication a des du propietaire. uction FCI ELEC | 95679-X04/X04LF | 4 | 58.42 | 41.91 | 26.670 | 53.34 | | | |
| ou commu n ecrite e reprod | 95679-X05/X05LF | 5 | 72.39 | 55.88 | 33.655 | 67.31 | | | |
| | 95679-X06/X06LF | 6 | 86.36 | 69.85 | 40.640 | 81.28 | | | |
| | 95679-X06P/X06PLF | 0 | 00.00 | | | 01.20 | NOTE 4 | | |
| Reproduction autorisation Droits d | 95679-X07/X07LF | 7 | 100.33 | 83.82 | 47.625 | 95.25 | | | |
| epro auto | 95679-X08/X08LF | 8 | 114.30 | 97.79 | 54.610 | 109.22 | - | | |
| strictement reserves. R forme que ce soit sans c FQD ELECTRONICS. | 95679-X09/X09LF | 9 | 128.27 | 111.76 | 61.595 | 123.19 | | | |
| | 95679-X10/X10LF | 10 | 142.24 | 125.73 | 68.580 | 137.16 | | | |
| | 95679-X11/X11LF | 11 | 156.21 | 139.70 | 75.565 | 151.13 | | | |
| ient que c | 95679-X12/X12LF | 12 | 170.18 | 153.67 | 82.550 | 165.10 | 1 | | |
| droits quelque ^iete de | | | | | | 8.89 TYP | | | |
| formaus sous Propi | | | / | | | | | | |

NOTES:

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1. APPLICABLE PC BOARD THICKNESS: 1.6 mm.

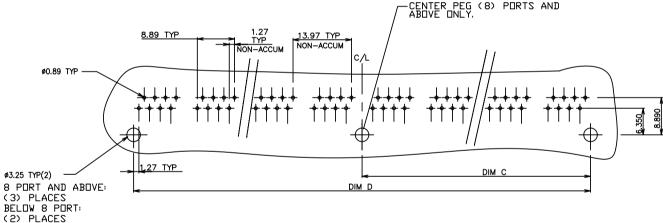
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- 2. CONTACTS: PHOSPHOR BRONZE ALLOY UNS-C51000, Ø0.460 ROUND WIRE,PLATING SEE TABLE.
- 3. CENTER PEG FOR 8 PORT AND ABOVE.
- (4.) OPTIONAL CENTER PEG IN PORT 6
- (95679-X06PLF) WITH CENTER PEG
 - (95679-X06LF) WITHOUT CENTER PEG
- (5.) PART NUMBERS WITH LF IN THE END ARE LEAD FREE.
- 4. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AN OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
- 5. THE HOUSING TEMPERATURE WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5 MM MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

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(6.) PLATING OPTION:

MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.



RECOMMENDED PC BOARD LAYOUT

| PLATING CODE X | PLATING 6 |
|----------------|------------|
| 0 | 30u"G.X.T. |
| 1 | 15u"GOLD. |
| 2 | 15u"G.X.T. |
| 3 | 30u" GOLD. |
| 5 | 50u" GOLD. |

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| mat'l. code | | | | | tolerances unless otherwise specified | | | | | | CUSTOMER | | | | | | | | | | | | | |
|-------------|------|------|------|-----|--|---|--------------------|----------|--------|------|----------|---------|--------------------|----------|------------------------|-----|-----|-------|-----------|------|------|--------|-----|--|
| ltr | ecn | no | dr | dat | e | .XX ±.01/.X±.3 | | | | COPY | | | www.fciconnect.com | | | | | | | | | | | |
| н | | | | | line | ur .) | XX ± | .005/ | '.XX ± | .13 | pro | ject | ion | tit | | | | | | | | | | |
| | | | | | | 1 | .XXXX±.0020/.XXX ± | | | | ±.051 | 4 | ς, | - | R/A CAT 5 GANG JACK AS | | | | | | | ASS | SSY | |
| | | | | | | angl | es | ≥5 0°±2° | | | | | ケヿ | 1 | 8 | POS | UN | SHIE | ELDED SNA | | | P PEG | | |
| | | | | | | dr L.POTTEIGER 8/30/95 | | | | | | | mm | | product family c | | | | | | | cod | e | |
| | | | | | | engr Y.BELOPOLSKY 8/30/95 Chr Y.BELOPOLSKY 8/30/95 | | | | 8/30 | 8/30/95 | | | | sizędwg no | | | | | | | 11 | NT | |
| | | | | | | | | | | sca | scale | | | A3 95679 | | | | | | shee | | | | |
| | | | | | | appd | Y.BE | | | | | 1 | 1:1 | | | | 9 | 10019 | | | | 2 of 2 | | |
| shee | et. | revi | sion | н | н | | | | | | | | | | | | | | | | | | | |
| inde | ex 🛛 | shee | et | 1 | 1 | | | | | | | | | | | | | | | | | | | |
| _ | 4 | | Rev | | | | | | | _ | | 5 as | | | | | · , | code | - ~ ~ | | 2010 | | 5 | |

form no. 7530-001-103

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